

### **GN2302-VB** Datasheet

## N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>e</sup>	Q <sub>g</sub> (Typ.)			
	0.028 at V <sub>GS</sub> = 4.5 V	6 <sup>a</sup>				
20	0.042 at V <sub>GS</sub> = 2.5 V	6 <sup>a</sup>	8.8 nC			
	0.050 at V <sub>GS</sub> = 1.8 V	5.6				

SOT-23

Top View

3 D

G 1

S 2

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- DC/DC Converters
- Load Switch for Portable Applications

	$1031_{A} = 250,$	unless otherwise	noteu	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	20	v
Gate-Source Voltage		V <sub>GS</sub>	± 12	V
	T <sub>C</sub> = 25 °C		6 <sup>a</sup>	
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C		5.1	
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	5 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1	4 <sup>b, c</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	20	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		1.75	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.04 <sup>b, c</sup>	
	T <sub>C</sub> = 25 °C		2.1	
Maximum Power Dissinction	T <sub>C</sub> = 70 °C		1.3	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.25 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C	1	0.8 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	0°
Soldering Recommendations (Peak Tempera	Ĭ	260	·U	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	80	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	40	60	0/10		

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 °C/W.

e. Based on T\_C = 25 °C.

FREE

Turn-Off Delay Time

Body Diode Voltage

Fall Time

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					www.\	/Bsemi.c
SPECIFICATIONS $T_J = 25 \ ^\circ C$	C, unless othei	wise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					-	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	20			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		25		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 <u>0</u> – 200 µ. (		- 2.6		1110/ 0
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.45		1.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA
	L	$V_{DS} = 20 V, V_{GS} = 0 V$			1	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	10			μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	20			А
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$	0.028			
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$		0.042		Ω
		$V_{GS} = 1.8 \text{ V}, I_D = 4.3 \text{ A}$		0.050		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.0 A		24		S
Dynamic <sup>b</sup>					<b>I</b>	I
Input Capacitance	C <sub>iss</sub>			865		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		105		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			55		
	Qg	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 5.0 A		12	18	
Total Gate Charge				8.8	14	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.0 \text{ A}$		1.1		
Gate-Drain Charge	Q <sub>gd</sub>			0.7		1
Gate Resistance	Rg	f = 1 MHz	0.5	2.4	4.8	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		17	26	1
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong \text{4}$ A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		31	47	1
Fall Time	t <sub>f</sub>			8	16	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.2 $\Omega$		13	20	-
			L			4

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

**Drain-Source Body Diode Characteristics** 

Continuous Source-Drain Diode Current

Body Diode Reverse Recovery Time

Body Diode Reverse Recovery Charge

Pulse Diode Forward Current

**Reverse Recovery Fall Time** 

Reverse Recovery Rise Time

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $I_D \cong 4 \text{ A}, V_{GEN} = 5 \text{ V}, R_g = 1 \Omega$ 

T<sub>C</sub> = 25 °C

 $I_{\rm S} = 4$  A,  $V_{\rm GS} = 0$  V

 $I_F = 4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ }^\circ\text{C}$ 

 $t_{d(off)}$ 

t<sub>f</sub>

 $I_S$ 

I<sub>SM</sub>

 $V_{SD}$ 

t<sub>rr</sub>

Q<sub>rr</sub>

ta

t<sub>b</sub>

21

6

0.75

12

5

7

5

32

12

1.75

20

1.2

20

10

А

٧

ns

nC

ns

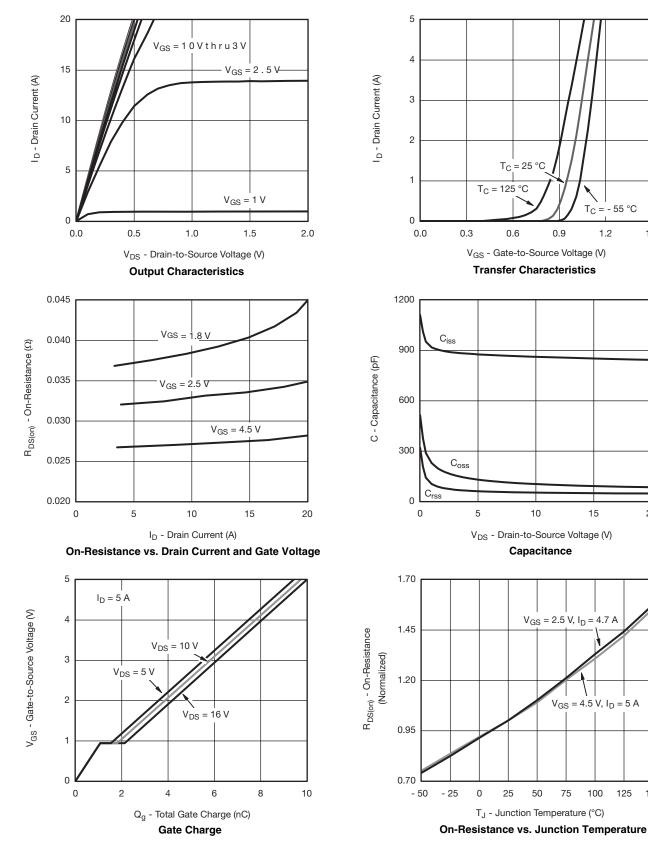


- 55 °C

1.5

20

1.2

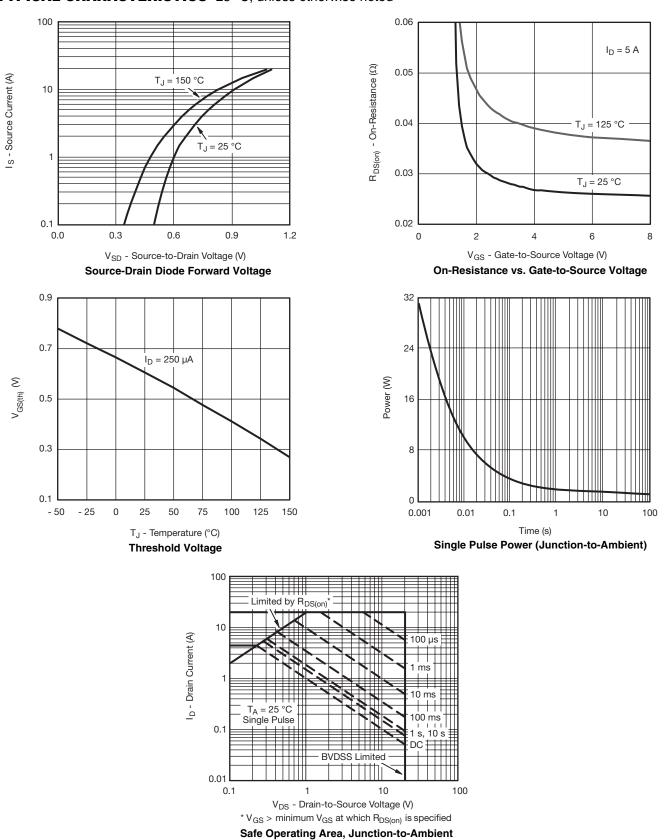


#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

服务热线:400-655-8788

125 150

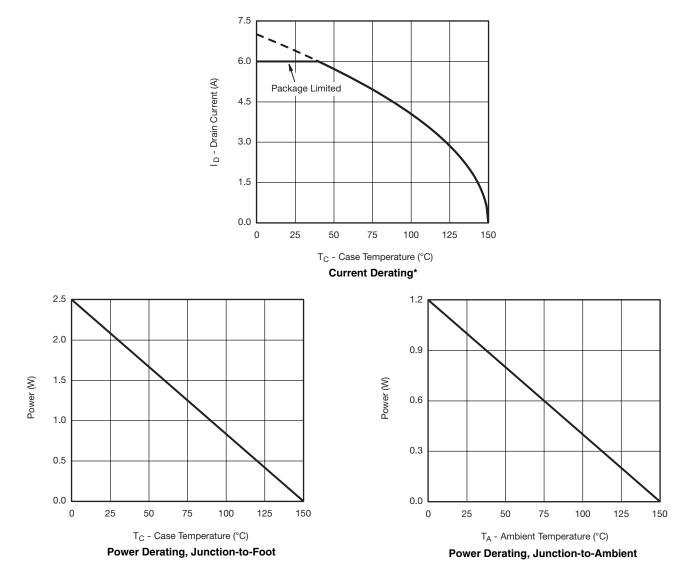




#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



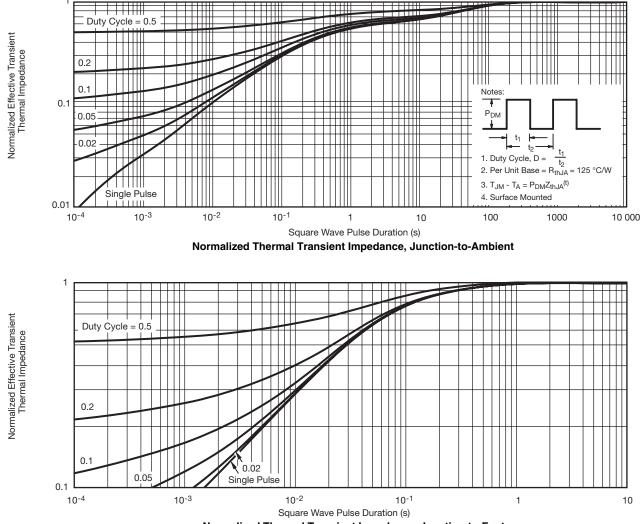
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



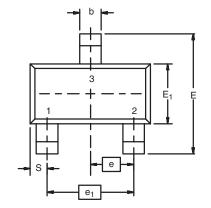
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



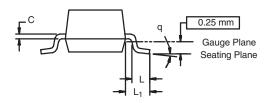
Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	IETERS	INCHES		
	Min	Мах	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01				



#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



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